

IFN40 N-Channel JFET

Features

- InterFET [N0016H Geometry](#)
- Low Noise: 5 nV/√Hz Typical
- Japanese 2SK40 Replacement
- RoHS Compliant
- SMT, TH, and Bare Die Package options.

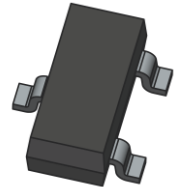
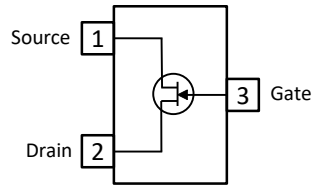
Applications

- Audio Amplifiers
- Small Signal Amplifier
- High Impedance Pre-Amplifier

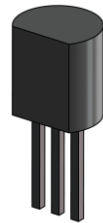
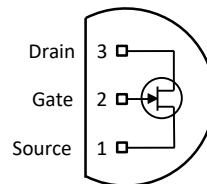
Description

The -50V InterFET IFN40 is a replacement for the Japanese 2SK40. Targeted for sensitive amplifier stages with gate leakages typically less than 10pA at room temperatures.

SOT23 Top View



TO-92 Bottom View



Product Summary

Parameters	IFN40 Min	Unit
BV_{GSS} Gate to Source Breakdown Voltage	-50	V
I_{DSS} Drain to Source Saturation Current	0.6	mA
$V_{GS(off)}$ Gate to Source Cutoff Voltage	-0.4	V
G_{FS} Forward Transconductance	2.0 (Typ)	mS

Ordering Information Custom Part and Binning Options Available

Part Number	Description	Case	Packaging
IFN40	Through-Hole	TO-92	Bulk
SMP40	Surface Mount	SOT23	Bulk
SMP40TR	7" Tape and Reel: Max 3,000 Pieces 13" Tape and Reel: Max 9,000 Pieces	SOT23	Minimum 1,000 Pieces Tape and Reel
IFN40COT	Chip Orientated Tray (COT Waffle Pack)	COT	400/Waffle Pack
IFN40CFT	Chip Face-up Tray (CFT Waffle Pack)	CFT	400/Waffle Pack



Disclaimer: It is the Buyers responsibility for designing, validating and testing the end application under all field use cases and extreme use conditions. Guaranteeing the application meets required standards, regulatory compliance, and all safety and security requirements is the responsibility of the Buyer. These resources are subject to change without notice.

Electrical Characteristics

Maximum Ratings (@ $T_A = 25^\circ\text{C}$, Unless otherwise specified)

Parameters	Value	Unit
V_{RGS} Reverse Gate Source and Gate Drain Voltage	-50	V
I_{FG} Continuous Forward Gate Current	50	mA
P_D Continuous Device Power Dissipation	300	mW
P Power Derating	2	mW/ $^\circ\text{C}$
T_J Operating Junction Temperature	-55 to 125	$^\circ\text{C}$
T_{STG} Storage Temperature	-65 to 175	$^\circ\text{C}$

Static Characteristics (@ $T_A = 25^\circ\text{C}$, Unless otherwise specified)

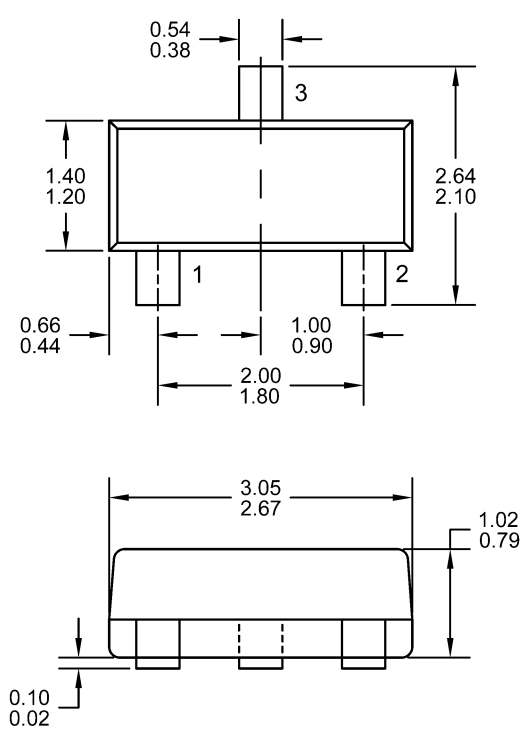
Parameters	Conditions	IFN40		Unit
		Min	Max	
$V_{(BR)GSS}$ Gate to Source Breakdown Voltage	$V_{DS} = 0V, I_G = -1\mu\text{A}$	-50		V
I_{GSS} Gate to Source Reverse Current	$V_{GS} = -30V, V_{DS} = 0V$		1.0	nA
$V_{GS(OFF)}$ Gate to Source Cutoff Voltage	$V_{DS} = 15V, I_D = 1\text{nA}$	-0.4	-5.0	V
I_{DSS} Drain to Source Saturation Current	$V_{GS} = 0V, V_{DS} = 15V$ (Pulsed)	0.6	6.5	mA

Dynamic Characteristics (@ $T_A = 25^\circ\text{C}$, Unless otherwise specified)

Parameters	Conditions	IFN40	Unit
		Typ	
G_{FS} Forward Transconductance	$V_{DS} = 15V, V_{GS} = 0V$	2.0	mS
C_{iss} Input Capacitance	$V_{GS} = 0V, V_{DS} = 15V$	4.0	pF
C_{rss} Reverse Transfer Capacitance	$V_{GS} = 0V, V_{DS} = 15V$	1.2	pF

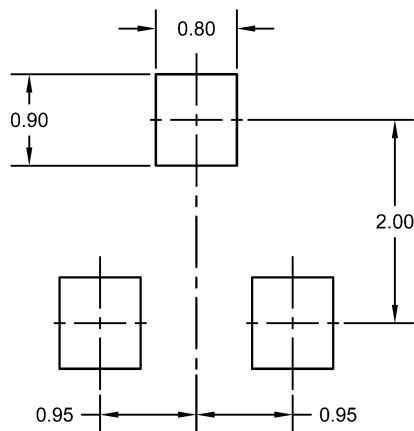
SOT23 (TO-236AB) Mechanical and Layout Data

Package Outline Data



1. All linear dimensions are in millimeters.
2. Package weight approximately 0.12 grams
3. Molded plastic case UL 94V-0 rated
4. For Tape and Reel specifications refer to InterFET CTC-021 Tape and Reel Specification, Document number: IF39002
5. Bulk product is shipped in standard ESD shipping material
6. Refer to JEDEC standards for additional information.

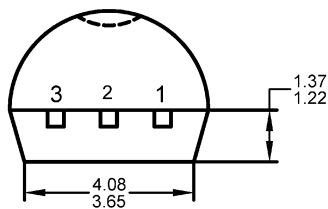
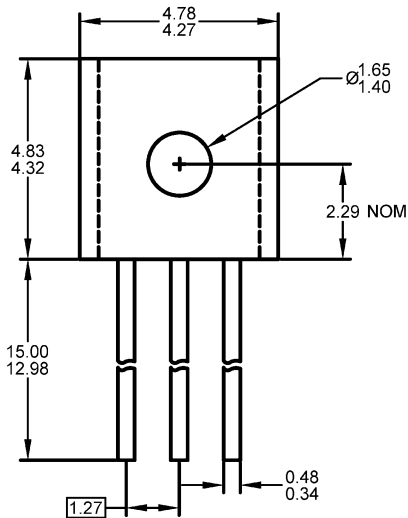
Suggested Pad Layout



1. All linear dimensions are in millimeters.
2. The suggested land pattern dimensions have been provided for reference only. A more robust pattern may be desired for wave soldering.

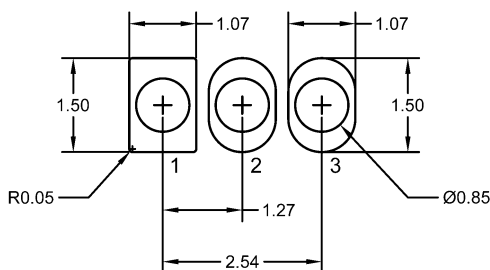
TO-92 Mechanical and Layout Data

Package Outline Data



1. All linear dimensions are in millimeters.
2. Package weight approximately 0.19 grams
3. Molded plastic case UL 94V-0 rated
4. Bulk product is shipped in standard ESD shipping material
5. Refer to JEDEC standards for additional information.

Suggested Through-Hole Layout



1. All linear dimensions are in millimeters.
2. The suggested land pattern dimensions have been provided as a straight lead reference only. A more robust pattern may be desired for wave soldering and/or bent lead configurations.